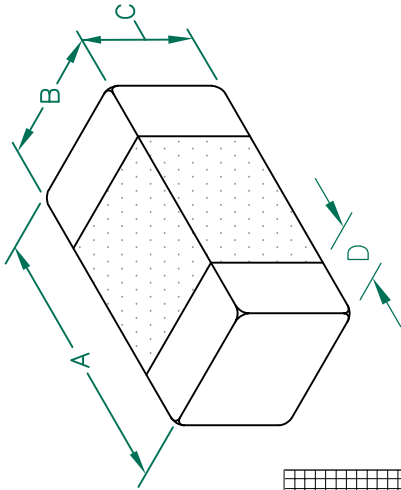


**UNCONTROLLED
DOCUMENT**

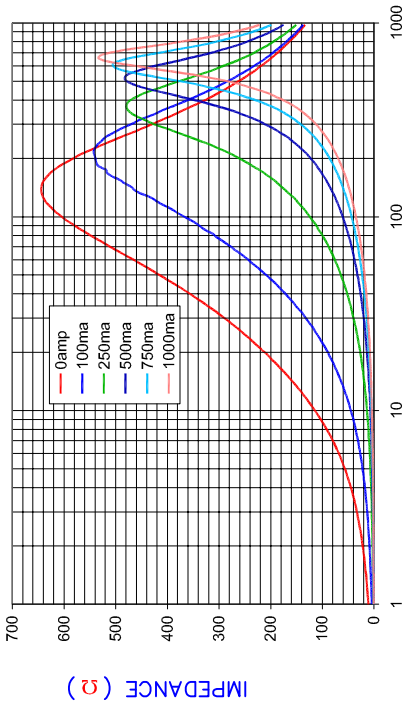
PHYSICAL DIMENSIONS:

A	1.60	[.063]	+ -	0.15	[.006]
B	0.80	[.031]	+ -	0.15	[.006]
C	0.80	[.031]	+ -	0.15	[.006]
D	0.36	[.014]	+ -	0.15	[.006]

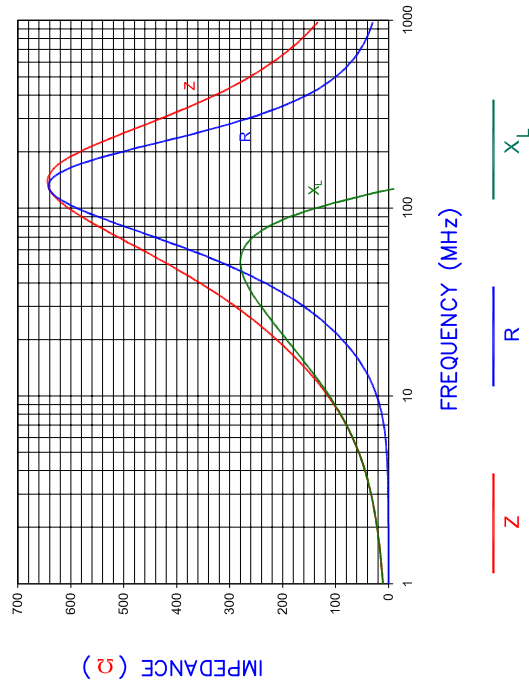


ELECTRICAL CHARACTERISTICS:

ELECTRICAL CHARACTERISTICS:		
Z @ 100MHz (Ω)	DCR (Ω)	Rated Current
Nominal	600	
Minimum	450	
Maximum	750	1000 mA

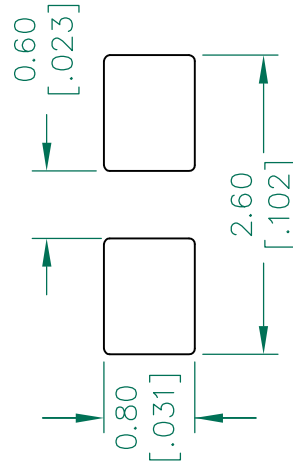


FREQUENCY (MHZ)

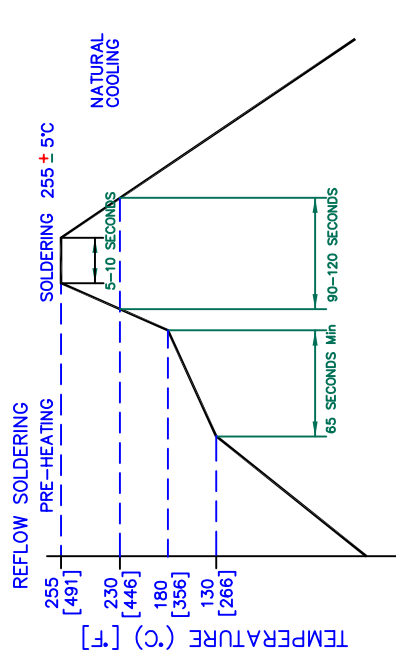


(For wave soldering, add 0.762 [".030"] to this dimension)

LAND PATTERNS FOR REFLOW SOLDERING



RECOMMENDED SOLDERING CONDITIONS



DIMENSIONS ARE IN mm [INCHES].

DIMENSIONS ARE IN mm [INCHES].					
C	ADD OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE	08/05/13	QU	MIO603J601R-10	C
B	UPDATE COMPANY LOGO	07/24/08	JRK	DATE:	SCALE:
A	ORIGINAL DRAFT	04/05/04	TMB	GAD #	TOOL #
REV	DESCRIPTION	DATE	INT		



AGILENT E4991A RF Impedance/Material Analyzer
HP 16194A Test Fixture. TEST REF. 3227